

# International Rectifier

## IGBT SIP MODULE

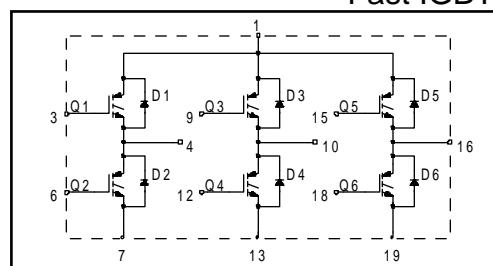
### Features

- Fully isolated printed circuit board mount package
- Switching-loss rating includes all "tail" losses
- HEXFRED™ soft ultrafast diodes
- Optimized for medium operating (1 to 10 kHz)  
See Fig. 1 for Current vs. Frequency curve

### Product Summary

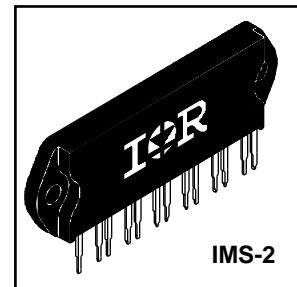
#### Output Current in a Typical 5.0 kHz Motor Drive

11 A<sub>RMS</sub> per phase (3.1 kW total) with T<sub>C</sub> = 90°C, T<sub>J</sub> = 125°C, Supply Voltage 360Vdc,  
Power Factor 0.8, Modulation Depth 115% (See Figure 1)



### Description

The IGBT technology is the key to International Rectifier's advanced line of IMS (Insulated Metal Substrate) Power Modules. These modules are more efficient than comparable bipolar transistor modules, while at the same time having the simpler gate-drive requirements of the familiar power MOSFET. This superior technology has now been coupled to a state of the art materials system that maximizes power throughput with low thermal resistance. This package is highly suited to motor drive applications and where space is at a premium.



### Absolute Maximum Ratings

|   | Parameter   | Max.                              | Units            |
|---|---|-----------------------------------|------------------|
| V <sub>CES</sub>                        | Collector-to-Emitter Voltage                      | 600                               | V                |
| I <sub>C</sub> @ T <sub>C</sub> = 25°C  | Continuous Collector Current, each IGBT           | 8.8                               | A                |
| I <sub>C</sub> @ T <sub>C</sub> = 100°C | Continuous Collector Current, each IGBT           | 4.8                               |                  |
| I <sub>CM</sub>                         | Pulsed Collector Current ①                        | 26                                |                  |
| I <sub>LM</sub>                         | Clamped Inductive Load Current ②                  | 26                                |                  |
| I <sub>F</sub> @ T <sub>C</sub> = 100°C | Diode Continuous Forward Current                  | 3.4                               |                  |
| I <sub>FM</sub>                         | Diode Maximum Forward Current                     | 26                                | V                |
| V <sub>GE</sub>                         | Gate-to-Emitter Voltage                           | ±20                               |                  |
| V <sub>ISOL</sub>                       | Isolation Voltage, any terminal to case, 1 minute | 2500                              | V <sub>RMS</sub> |
| P <sub>D</sub> @ T <sub>C</sub> = 25°C  | Maximum Power Dissipation, each IGBT              | 23                                | W                |
| P <sub>D</sub> @ T <sub>C</sub> = 100°C | Maximum Power Dissipation, each IGBT              | 9.1                               |                  |
| T <sub>J</sub>                          | Operating Junction and                            | -40 to +150                       | °C               |
| T <sub>STG</sub>                        | Storage Temperature Range                         |                                   |                  |
|   | Soldering Temperature, for 10 sec.                |                                   |                  |
|   | Mounting torque, 6-32 or M3 screw                 | 300 (0.063 in. (1.6mm) from case) |                  |
|   |   | 5-7 lbf·in (0.55-0.8 N·m)         |                  |

### Thermal Resistance

|                           | Parameter   | Typ.     | Max. | Units  |
|---------------------------|---|----------|------|--------|
| R <sub>θJC</sub> (IGBT)   | Junction-to-Case, each IGBT, one IGBT in conduction   | —        | 5.5  | °C/W   |
| R <sub>θJC</sub> (DIODE)  | Junction-to-Case, each diode, one diode in conduction | —        | 9.0  |        |
| R <sub>θCS</sub> (MODULE) | Case-to-Sink, flat, greased surface                   | 0.1      | —    |        |
| Wt                        | Weight of module                                      | 20 (0.7) | —    | g (oz) |

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## Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

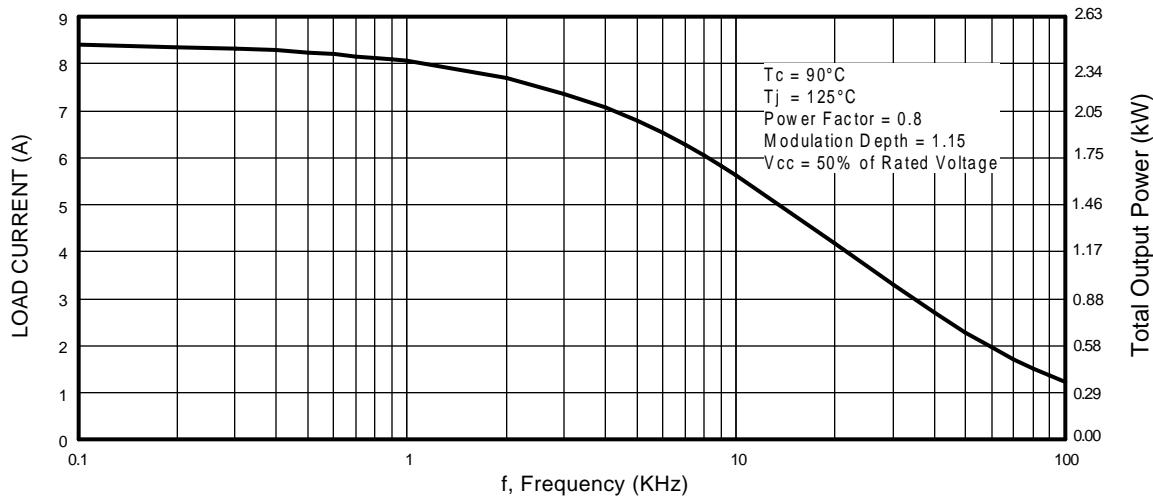
|   | Parameter   | Min. | Typ. | Max.      | Units                      | Conditions  |                              |
|---|---|------|------|-----------|----------------------------|---|------------------------------|
| $V_{(\text{BR})\text{CES}}$                   | Collector-to-Emitter Breakdown Voltage <sup>③</sup> | 600  | —    | —         | V                          | $V_{\text{GE}} = 0\text{V}$ , $I_C = 250\mu\text{A}$                                    |                              |
| $\Delta V_{(\text{BR})\text{CES}/\Delta T_J}$ | Temperature Coeff. of Breakdown Voltage             | —    | 0.72 | —         | $\text{V}/^\circ\text{C}$  | $V_{\text{GE}} = 0\text{V}$ , $I_C = 1.0\text{mA}$                                      |                              |
| $V_{\text{CE}(\text{on})}$                    | Collector-to-Emitter Saturation Voltage             | —    | 1.41 | 1.7       | V                          | $I_C = 4.8\text{A}$   | $V_{\text{GE}} = 15\text{V}$ |
|   |   | —    | 1.66 | —         |                            | $I_C = 8.8\text{A}$   | See Fig. 2, 5                |
|   |   | —    | 1.42 | —         |                            | $I_C = 4.8\text{A}$ , $T_J = 150^\circ\text{C}$   |                              |
| $V_{\text{GE}(\text{th})}$                    | Gate Threshold Voltage                              | 3.0  | —    | 6.0       |                            | $V_{\text{CE}} = V_{\text{GE}}$ , $I_C = 250\mu\text{A}$                                |                              |
| $\Delta V_{\text{GE}(\text{th})/\Delta T_J}$  | Temperature Coeff. of Threshold Voltage             | —    | -11  | —         | $\text{mV}/^\circ\text{C}$ | $V_{\text{CE}} = V_{\text{GE}}$ , $I_C = 250\mu\text{A}$                                |                              |
| $g_{\text{fe}}$                               | Forward Transconductance <sup>④</sup>               | 2.9  | 5.0  | —         | S                          | $V_{\text{CE}} = 100\text{V}$ , $I_C = 4.8\text{A}$                                     |                              |
| $I_{\text{CES}}$                              | Zero Gate Voltage Collector Current                 | —    | —    | 250       | $\mu\text{A}$              | $V_{\text{GE}} = 0\text{V}$ , $V_{\text{CE}} = 600\text{V}$                             |                              |
|   |   | —    | —    | 1700      |                            | $V_{\text{GE}} = 0\text{V}$ , $V_{\text{CE}} = 600\text{V}$ , $T_J = 150^\circ\text{C}$ |                              |
| $V_{\text{FM}}$                               | Diode Forward Voltage Drop                          | —    | 1.4  | 1.7       | V                          | $I_C = 8.0\text{A}$   | See Fig. 13                  |
|   |   | —    | 1.3  | 1.6       |                            | $I_C = 8.0\text{A}$ , $T_J = 150^\circ\text{C}$   |                              |
| $I_{\text{GES}}$                              | Gate-to-Emitter Leakage Current                     | —    | —    | $\pm 100$ | nA                         | $V_{\text{GE}} = \pm 20\text{V}$  |                              |

## Switching Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

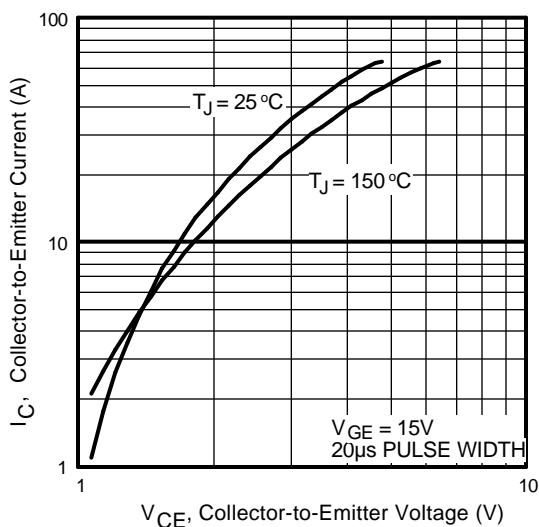
|                                | Parameter  | Min. | Typ. | Max. | Units            | Conditions  |            |
|--------------------------------|--|------|------|------|------------------|---|------------|
| $Q_g$                          | Total Gate Charge (turn-on)                      | —    | 30   | 45   | nC               | $I_C = 4.8\text{A}$                                     |            |
| $Q_{\text{ge}}$                | Gate - Emitter Charge (turn-on)                  | —    | 4.0  | 6.0  |                  | $V_{\text{CC}} = 400\text{V}$                           |            |
| $Q_{\text{gc}}$                | Gate - Collector Charge (turn-on)                | —    | 13   | 20   |                  | See Fig. 8  |            |
| $t_{\text{d}(\text{on})}$      | Turn-On Delay Time                               | —    | 49   | —    | ns               | $T_J = 25^\circ\text{C}$                                |            |
| $t_r$                          | Rise Time  | —    | 22   | —    |                  | $I_C = 4.8\text{A}$ , $V_{\text{CC}} = 480\text{V}$     |            |
| $t_{\text{d}(\text{off})}$     | Turn-Off Delay Time                              | —    | 200  | 300  |                  | $V_{\text{GE}} = 15\text{V}$ , $R_G = 50\Omega$         |            |
| $t_f$                          | Fall Time  | —    | 214  | 320  |                  | Energy losses include "tail" and diode reverse recovery |            |
| $E_{\text{on}}$                | Turn-On Switching Loss                           | —    | 0.23 | —    | mJ               | See Fig. 9, 10, 18                                      |            |
| $E_{\text{off}}$               | Turn-Off Switching Loss                          | —    | 0.33 | —    |                  |   |            |
| $E_{\text{ts}}$                | Total Switching Loss                             | —    | 0.45 | 0.70 |                  |   |            |
| $t_{\text{d}(\text{on})}$      | Turn-On Delay Time                               | —    | 48   | —    | ns               | $T_J = 150^\circ\text{C}$ , See Fig. 10,11, 18          |            |
| $t_r$                          | Rise Time  | —    | 25   | —    |                  | $I_C = 4.8\text{A}$ , $V_{\text{CC}} = 480\text{V}$     |            |
| $t_{\text{d}(\text{off})}$     | Turn-Off Delay Time                              | —    | 435  | —    |                  | $V_{\text{GE}} = 15\text{V}$ , $R_G = 50\Omega$         |            |
| $t_f$                          | Fall Time  | —    | 364  | —    |                  | Energy losses include "tail" and diode reverse recovery |            |
| $E_{\text{ts}}$                | Total Switching Loss                             | —    | 0.93 | —    | mJ               |   |            |
| $C_{\text{ies}}$               | Input Capacitance                                | —    | 340  | —    | pF               | $V_{\text{GE}} = 0\text{V}$                             |            |
| $C_{\text{oes}}$               | Output Capacitance                               | —    | 63   | —    |                  | $V_{\text{CC}} = 30\text{V}$                            | See Fig. 7 |
| $C_{\text{res}}$               | Reverse Transfer Capacitance                     | —    | 5.9  | —    |                  | $f = 1.0\text{MHz}$                                     |            |
| $t_{\text{rr}}$                | Diode Reverse Recovery Time                      | —    | 37   | 55   | ns               | $T_J = 25^\circ\text{C}$                                | See Fig.   |
|                                |  | —    | 55   | 90   |                  | $T_J = 125^\circ\text{C}$                               | 14         |
| $I_{\text{rr}}$                | Diode Peak Reverse Recovery Current              | —    | 3.5  | 50   | A                | $T_J = 25^\circ\text{C}$                                | See Fig.   |
|                                |  | —    | 4.5  | 8.0  |                  | $T_J = 125^\circ\text{C}$                               | 15         |
| $Q_{\text{rr}}$                | Diode Reverse Recovery Charge                    | —    | 65   | 138  | nC               | $T_J = 25^\circ\text{C}$                                | See Fig.   |
|                                |  | —    | 124  | 360  |                  | $T_J = 125^\circ\text{C}$                               | 16         |
| $di_{(\text{rec})\text{M}/dt}$ | Diode Peak Rate of Fall of Recovery During $t_b$ | —    | 240  | —    | A/ $\mu\text{s}$ | $T_J = 25^\circ\text{C}$                                | See Fig.   |
|                                |  | —    | 210  | —    |                  | $T_J = 125^\circ\text{C}$                               | 17         |

### Notes:

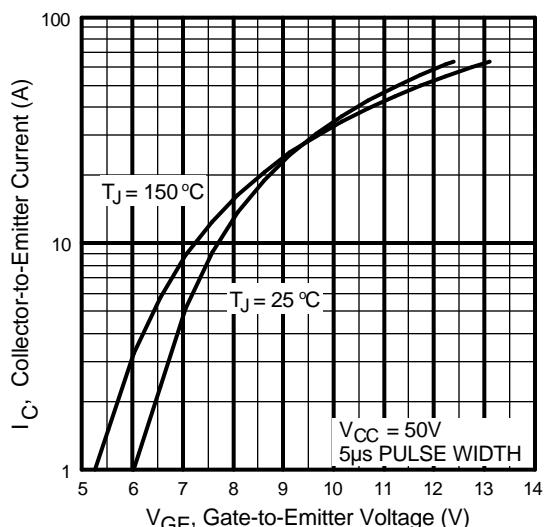
- ① Repetitive rating;  $V_{\text{GE}}=20\text{V}$ , pulse width limited by max. junction temperature. ( See fig. 20 )
- ②  $V_{\text{CC}}=80\%(V_{\text{CES}})$ ,  $V_{\text{GE}}=20\text{V}$ ,  $L=10\mu\text{H}$ ,  $R_G=50\Omega$ , ( See fig. 19 )
- ③ Pulse width  $\leq 80\mu\text{s}$ ; duty factor  $\leq 0.1\%$ .
- ④ Pulse width  $5.0\mu\text{s}$ , single shot.



**Fig. 1 - Typical Load Current vs. Frequency**  
(Load Current =  $I_{RMS}$  of fundamental)



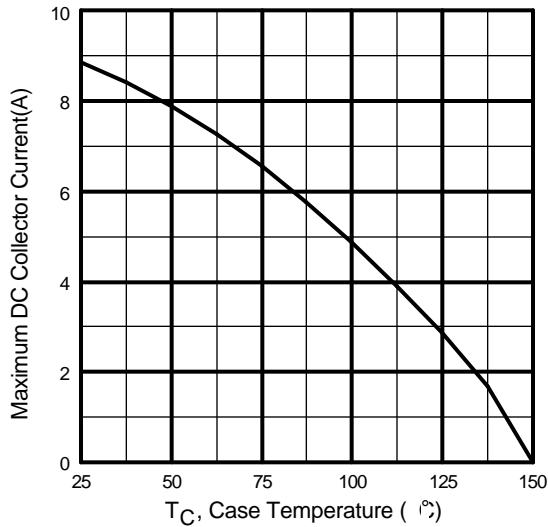
**Fig. 2 - Typical Output Characteristics**



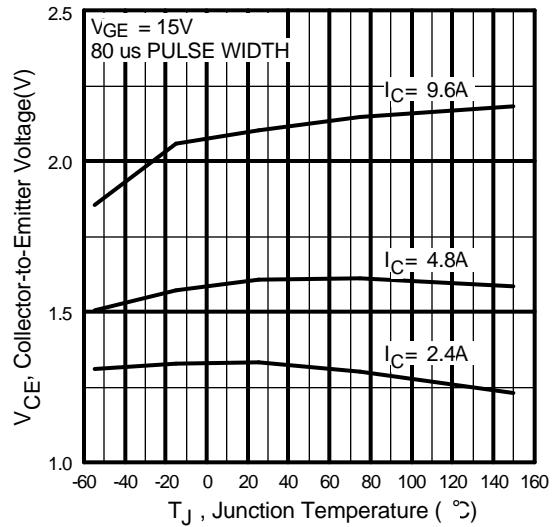
**Fig. 3 - Typical Transfer Characteristics**

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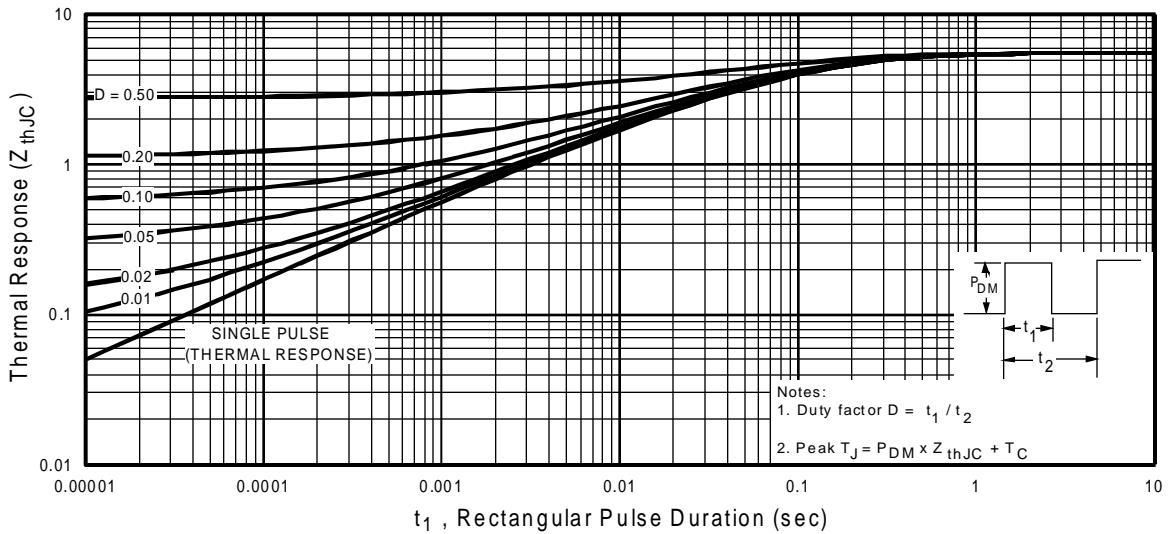
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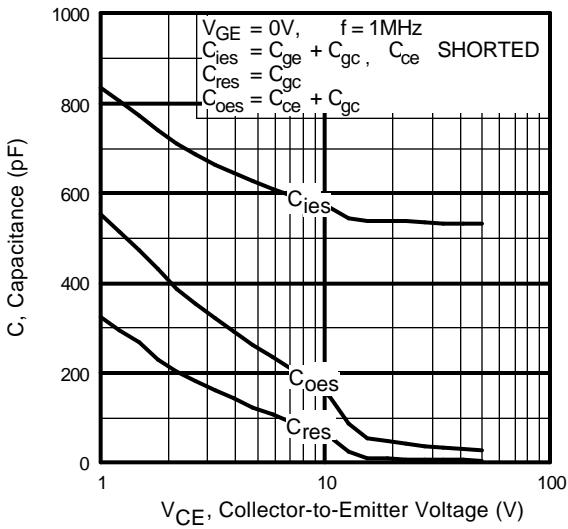
**Fig. 4 - Maximum Collector Current vs. Case Temperature**



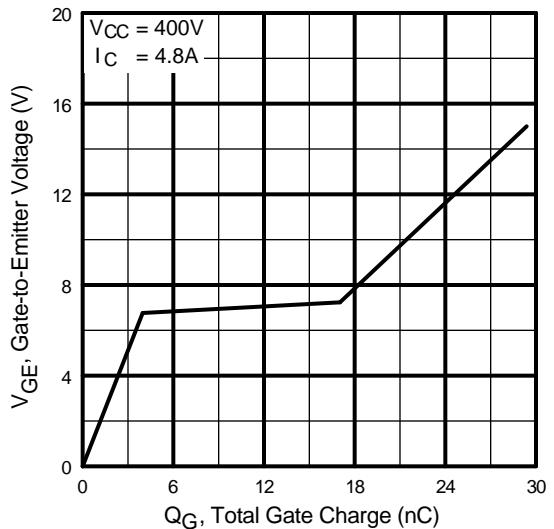
**Fig. 5 - Typical Collector-to-Emitter Voltage vs. Junction Temperature**



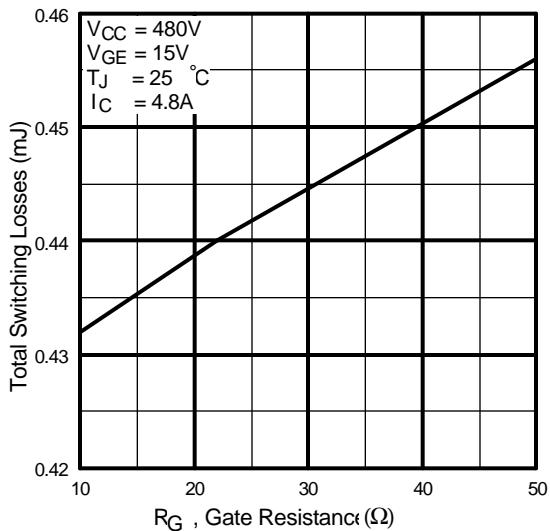
**Fig. 6 - Maximum Effective Transient Thermal Impedance, Junction-to-Case**



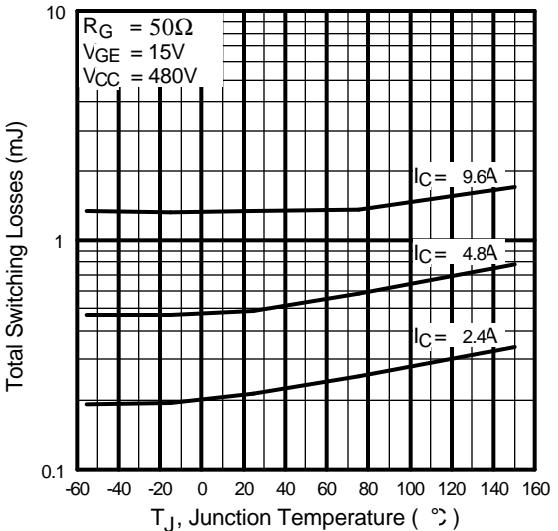
**Fig. 7 - Typical Capacitance vs. Collector-to-Emitter Voltage**



**Fig. 8 - Typical Gate Charge vs. Gate-to-Emitter Voltage**



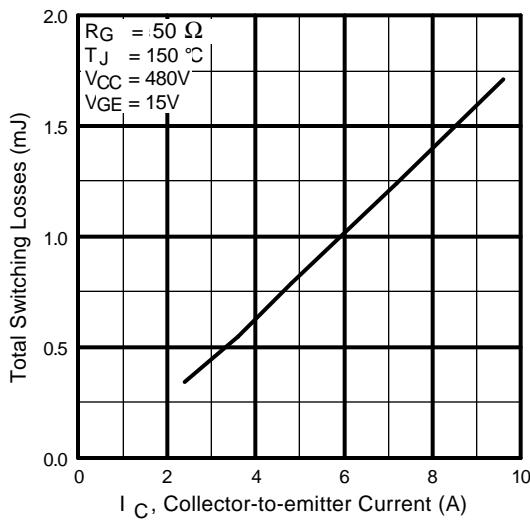
**Fig. 9 - Typical Switching Losses vs. Gate Resistance**



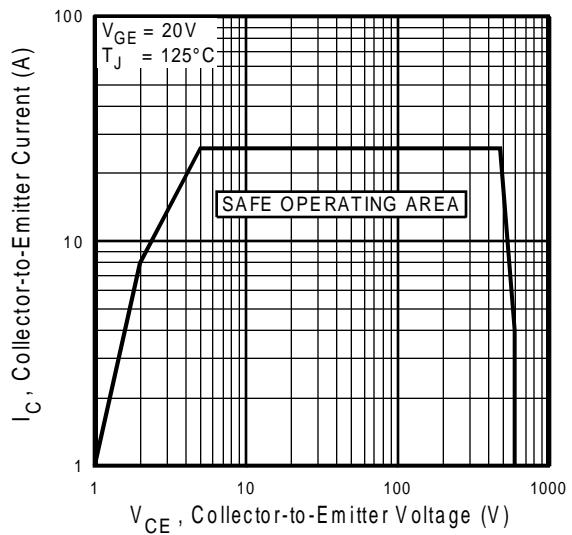
**Fig. 10 - Typical Switching Losses vs. Junction Temperature**

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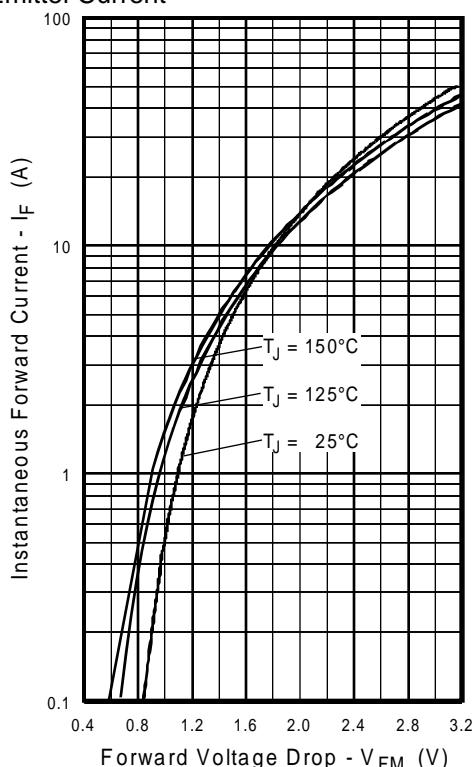
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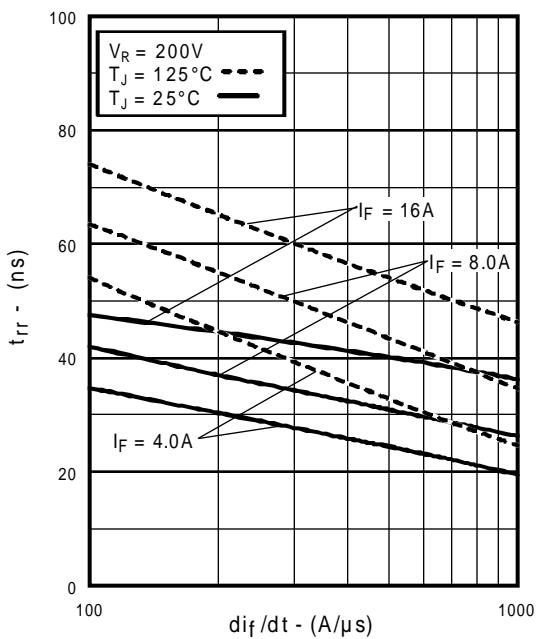
**Fig. 11 - Typical Switching Losses vs.  
Collector-to-Emitter Current**



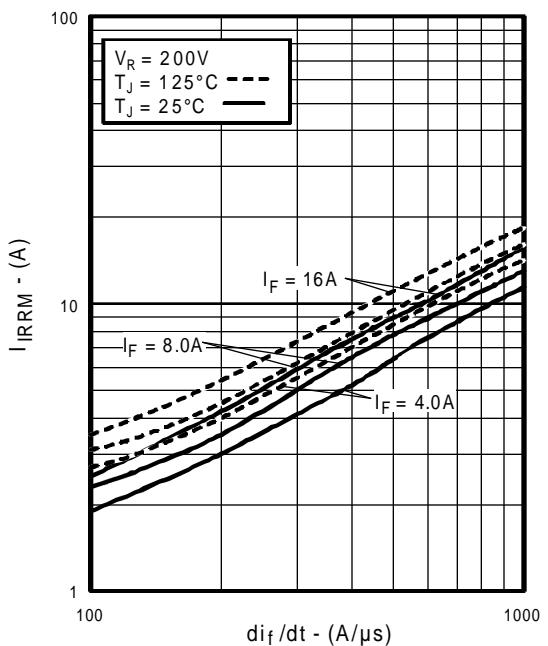
**Fig. 12 - Turn-Off SOA**



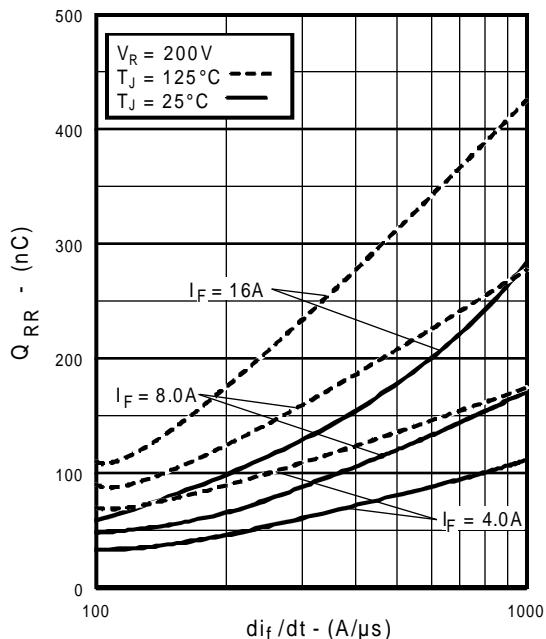
**Fig. 13 - Maximum Forward Voltage Drop vs. Instantaneous Forward Current**



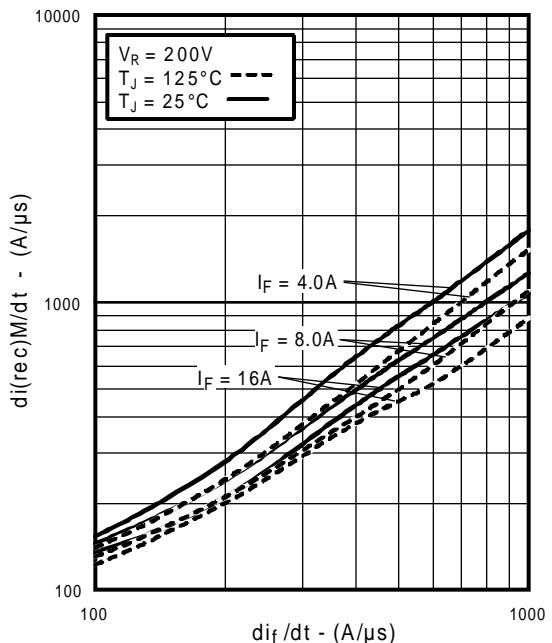
**Fig. 14** - Typical Reverse Recovery vs.  $di_f/dt$



**Fig. 15** - Typical Recovery Current vs.  $di_f/dt$

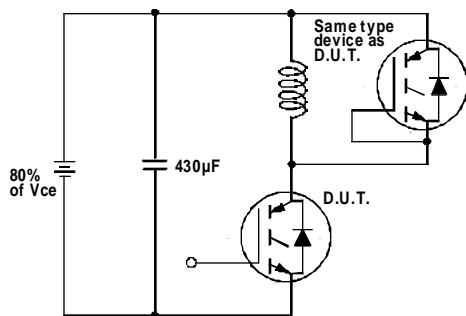


**Fig. 16** - Typical Stored Charge vs.  $di_f/dt$

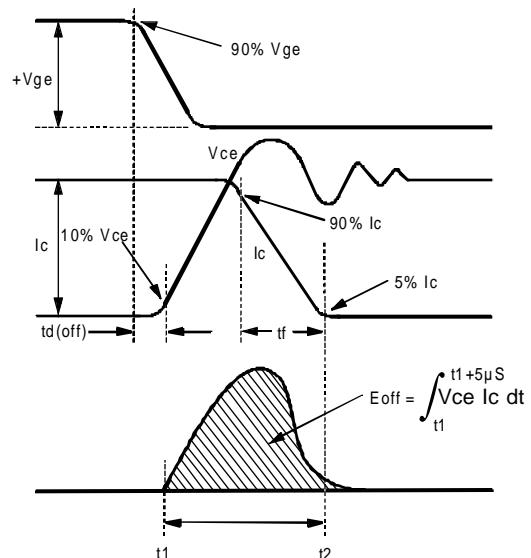


**Fig. 17** - Typical  $di_{(rec)}/dt$  vs.  $di_f/dt$

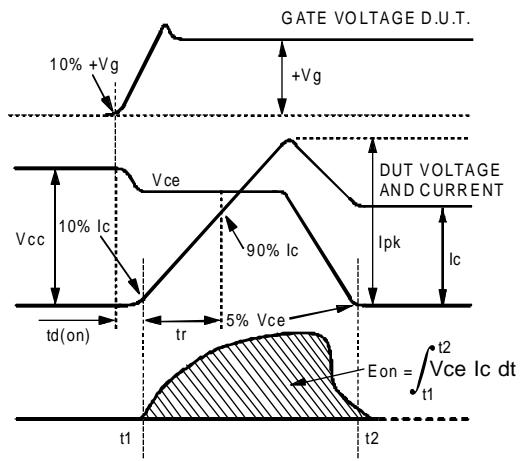
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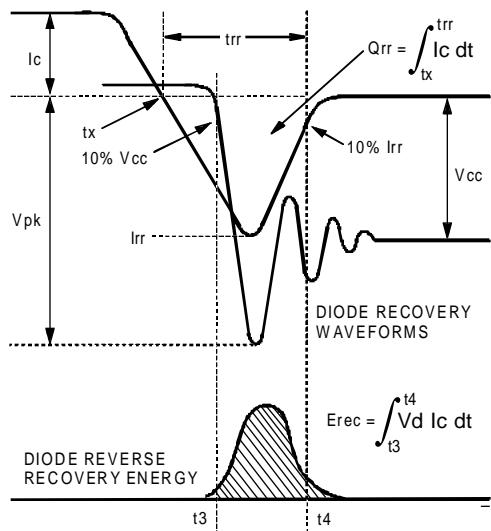
**Fig. 18a** - Test Circuit for Measurement of  $I_{LM}$ ,  $E_{on}$ ,  $E_{off(diode)}$ ,  $t_{rr}$ ,  $Q_{rr}$ ,  $I_{rr}$ ,  $t_d(on)$ ,  $t_r$ ,  $t_d(off)$ ,  $t_f$



**Fig. 18b** - Test Waveforms for Circuit of Fig. 18a, Defining  $E_{off}$ ,  $t_d(off)$ ,  $t_f$



**Fig. 18c** - Test Waveforms for Circuit of Fig. 18a, Defining  $E_{on}$ ,  $t_d(on)$ ,  $t_r$



**Fig. 18d** - Test Waveforms for Circuit of Fig. 18a, Defining  $E_{rec}$ ,  $t_{rr}$ ,  $Q_{rr}$ ,  $I_{rr}$

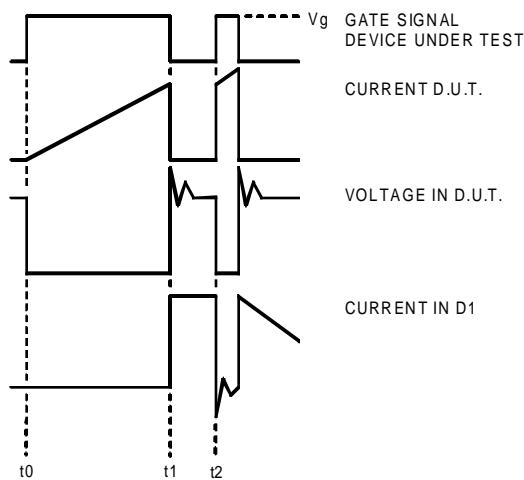


Figure 18e. Macro Waveforms for Figure 18a's Test Circuit

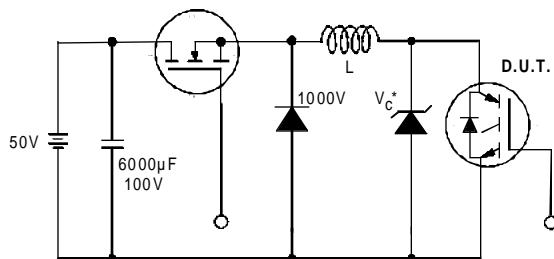


Figure 19. Clamped Inductive Load Test Circuit

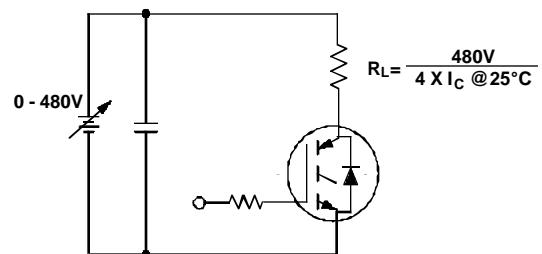
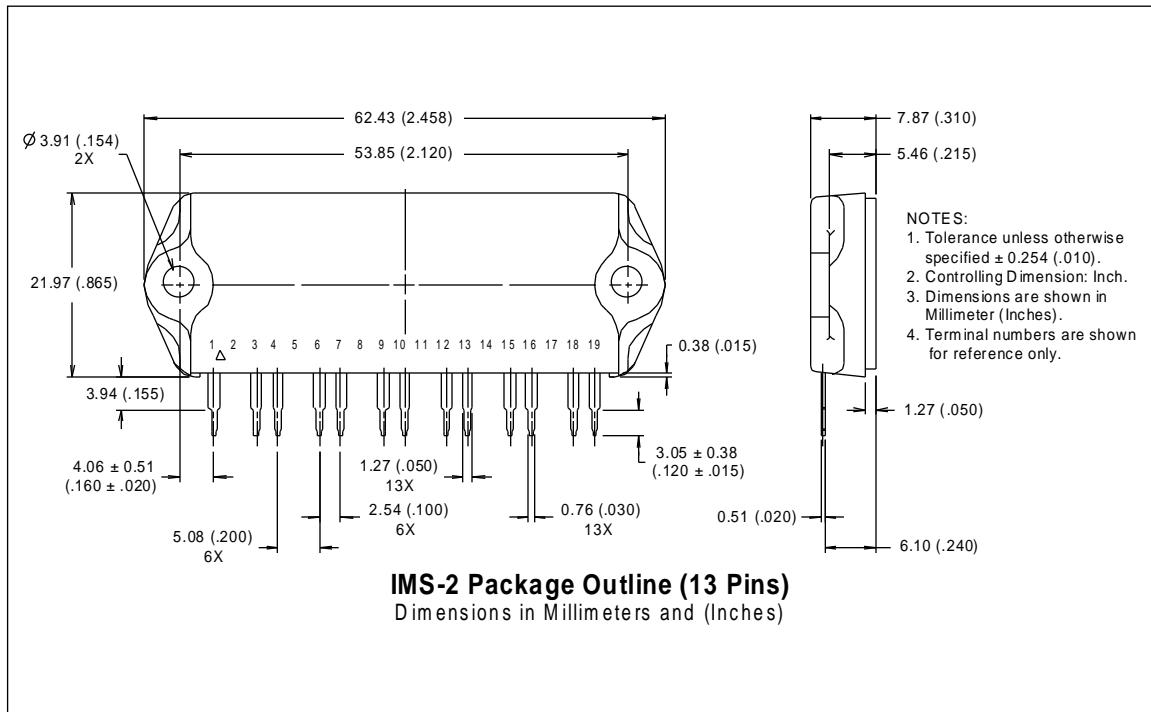


Figure 20. Pulsed Collector Current Test Circuit

## Notes:

- ① Repetitive rating:  $V_{GE}=20V$ ; pulse width limited by maximum junction temperature (figure 20)
- ②  $V_{CC}=80\% (V_{CES})$ ,  $V_{GE}=20V$ ,  $L=10\mu H$ ,  $R_G = 22\Omega$  (figure 19)
- ③ Pulse width  $\leq 80\mu s$ ; duty factor  $\leq 0.1\%$ .
- ④ Pulse width 5.0 $\mu s$ , single shot.

## Case Outline — IMS-2



International  
**IR** Rectifier

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**IR ITALY:** Via Liguria 49, 10071 Borgaro, Torino Tel: ++ 39 11 451 0111

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